



SamHop Microelectronics Corp.

**STP15L01/F**

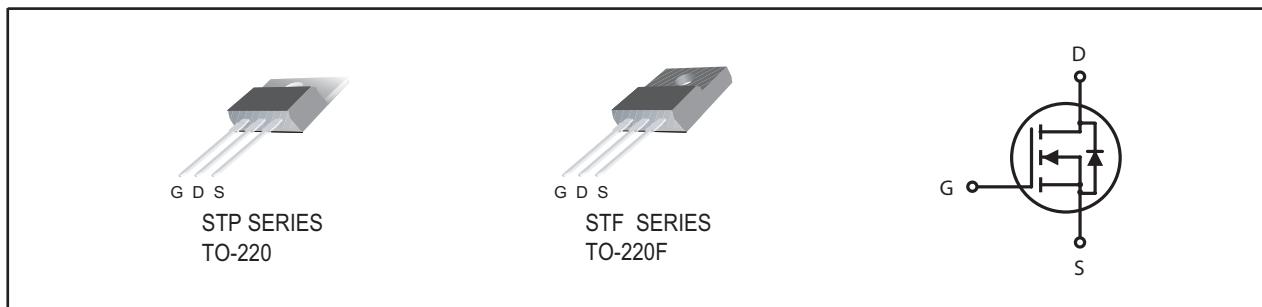
Ver1.0

N-Channel Enhancement Mode Field Effect Transistor

PRODUCT SUMMARY		
V _{DSS}	I _D	R _{DSON} (mΩ) Typ
100V	15A	110 @ V _{GS} =10V
		121 @ V _{GS} =4.5V

FEATURES

- Super high dense cell design for low R_{DSON}.
- Rugged and reliable.
- TO-220 and TO-220F Package.



ABSOLUTE MAXIMUM RATINGS ($T_C=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	TO-220	TO-220F	Units
V _{DS}	Drain-Source Voltage	100		V
V _{GS}	Gate-Source Voltage	± 20	± 20	V
I _D	Drain Current-Continuous ^a	15	15 ^e	A
		12.6	12.6 ^e	A
I _{DM}	-Pulsed ^b	45	45 ^e	A
E _{AS}	Single Pulse Avalanche Energy ^d	25		mJ
P _D	Maximum Power Dissipation ^a	58	25	W
		40	17.5	W
T _J , T _{STG}	Operating Junction and Storage Temperature Range	-55 to 175		°C

THERMAL CHARACTERISTICS

R _{θJC}	Thermal Resistance, Junction-to-Case ^a	2.6	6	°C/W
R _{θJA}	Thermal Resistance, Junction-to-Ambient ^a	62.5	62.5	°C/W

Details are subject to change without notice.

Nov,01,2010

STP15L01/F

Ver1.0

ELECTRICAL CHARACTERISTICS ($T_A=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
OFF CHARACTERISTICS						
BVDSS	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	100			V
IDS _S	Zero Gate Voltage Drain Current	$V_{DS}=80V, V_{GS}=0V$			1	μA
IGSS	Gate-Body Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$			± 100	nA
ON CHARACTERISTICS						
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	1	1.7	3	V
R _{DSON}	Drain-Source On-State Resistance	$V_{GS}=10V, I_D=7A$		110	138	m-ohm
		$V_{GS}=4.5V, I_D=6A$		121	163	m-ohm
g _{FS}	Forward Transconductance	$V_{DS}=20V, I_D=7A$		15		S
DYNAMIC CHARACTERISTICS ^c						
C _{ISS}	Input Capacitance	$V_{DS}=25V, V_{GS}=0V$ $f=1.0MHz$		675		pF
C _{OSS}	Output Capacitance			48		pF
C _{RSS}	Reverse Transfer Capacitance			32		pF
SWITCHING CHARACTERISTICS ^c						
t _{D(ON)}	Turn-On Delay Time	$V_{DD}=50V$ $I_D=1A$ $V_{GS}=10V$ R _{GEN} = 6 ohm		16		ns
t _r	Rise Time			14.5		ns
t _{D(OFF)}	Turn-Off Delay Time			31		ns
t _f	Fall Time			6.4		ns
Q _g	Total Gate Charge	$V_{DS}=50V, I_D=7A, V_{GS}=10V$		12.4		nC
		$V_{DS}=50V, I_D=7A, V_{GS}=4.5V$		6.4		nC
Q _{gs}	Gate-Source Charge	$V_{DS}=50V, I_D=7A,$ $V_{GS}=10V$		1.7		nC
Q _{gd}	Gate-Drain Charge			3.5		nC
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
V _{SD}	Diode Forward Voltage	$V_{GS}=0V, I_S=2A$		0.8	1.3	V
Notes						
a. Surface Mounted on FR4 Board, $t \leq 10sec$.						
b. Pulse Test: Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$.						
c. Guaranteed by design, not subject to production testing.						
d. Starting $T_J=25^\circ C, L=0.5mH, V_{DD}=50V$. (See Figure12)						
e. Drain current limited by maximum junction temperature.						

Nov,01,2010

STP15L01/F

Ver 1.0

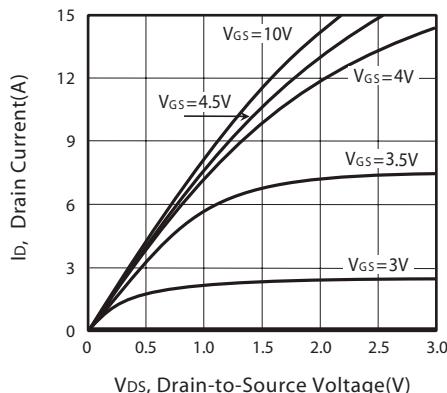


Figure 1. Output Characteristics

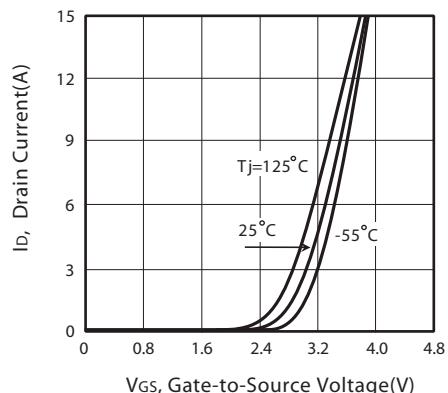


Figure 2. Transfer Characteristics

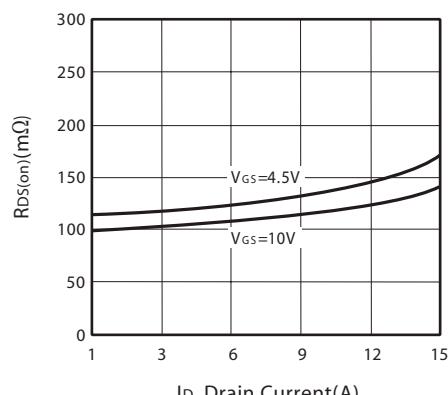


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

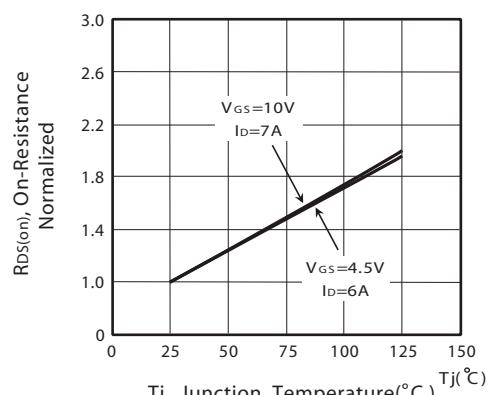


Figure 4. On-Resistance Variation with Drain Current and Temperature

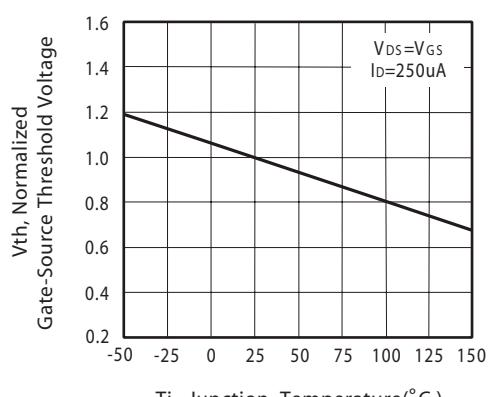


Figure 5. Gate Threshold Variation with Temperature

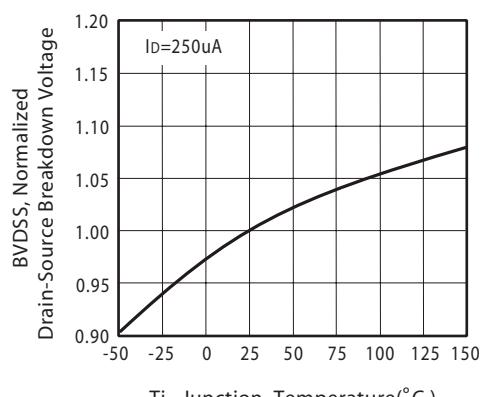


Figure 6. Breakdown Voltage Variation with Temperature

Nov,01,2010

STP15L01/F

Ver 1.0

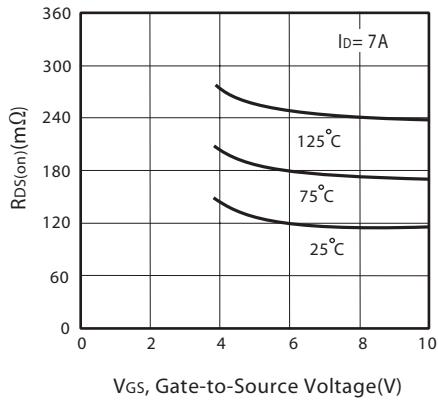


Figure 7. On-Resistance vs.
Gate-Source Voltage

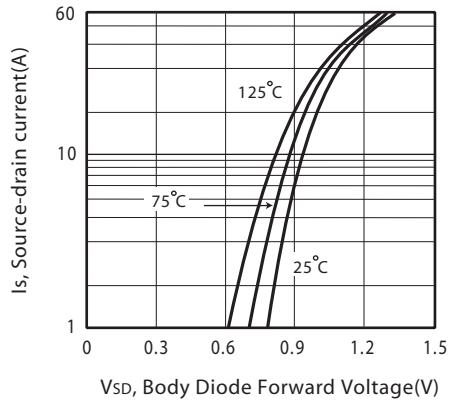


Figure 8. Body Diode Forward Voltage
Variation with Source Current

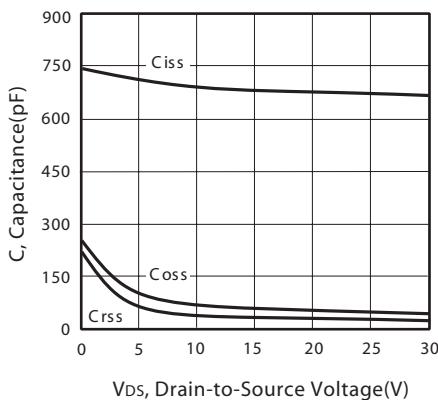


Figure 9. Capacitance

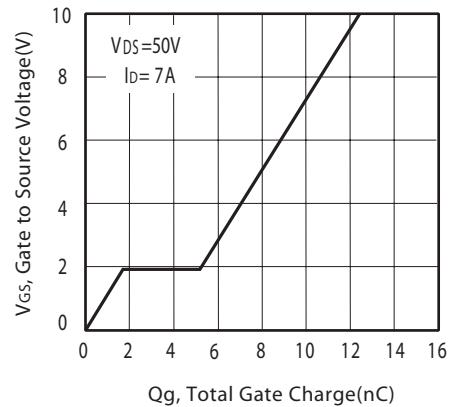


Figure 10. Gate Charge

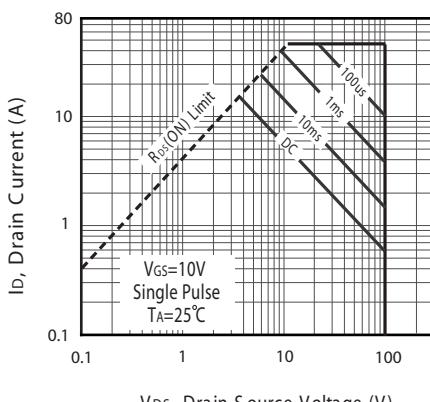


Figure 11a. Maximum Safe Operating
Area for STP15L01

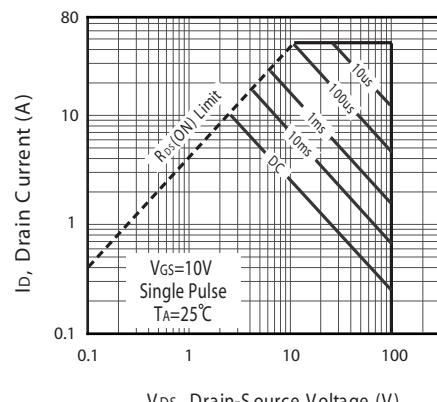
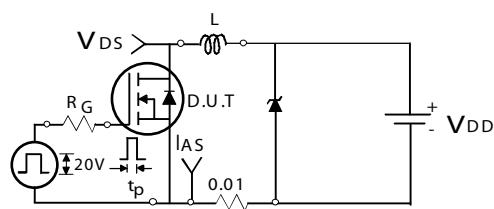


Figure 11b. Maximum Safe Operating
Area for STP15L01F

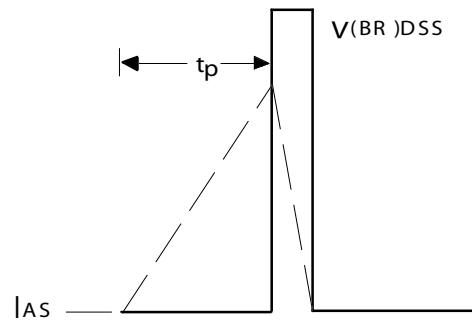
STP15L01/F

Ver 1.0



Unclamped Inductive Test Circuit

Figure 12a.



Unclamped Inductive Waveforms

Figure 12b.

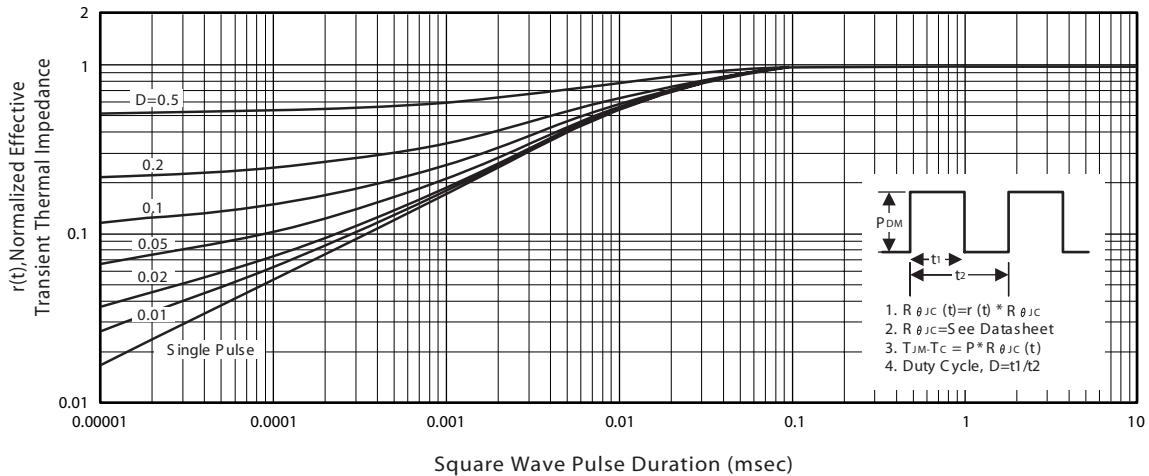


Figure 13a. Normalized Thermal Transient Impedance Curve for STP15L01

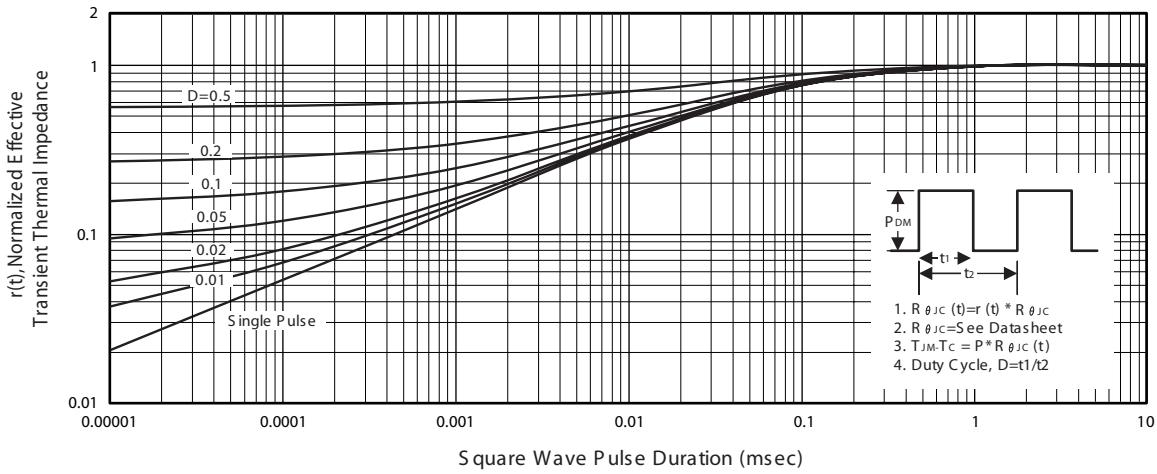
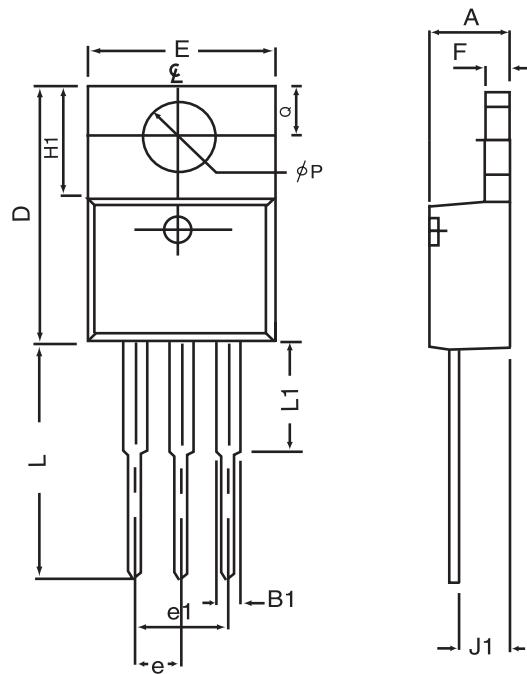


Figure 13b. Normalized Thermal Transient Impedance Curve for STP15L01F

Nov,01,2010

PACKAGE OUTLINE DIMENSIONS

TO-220



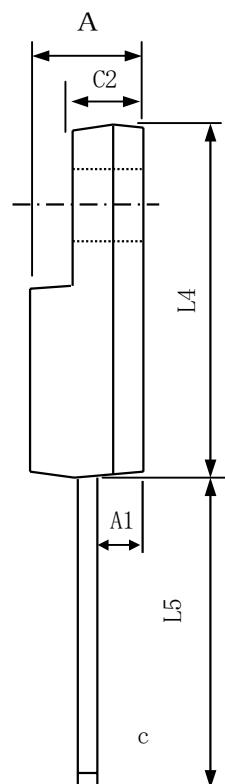
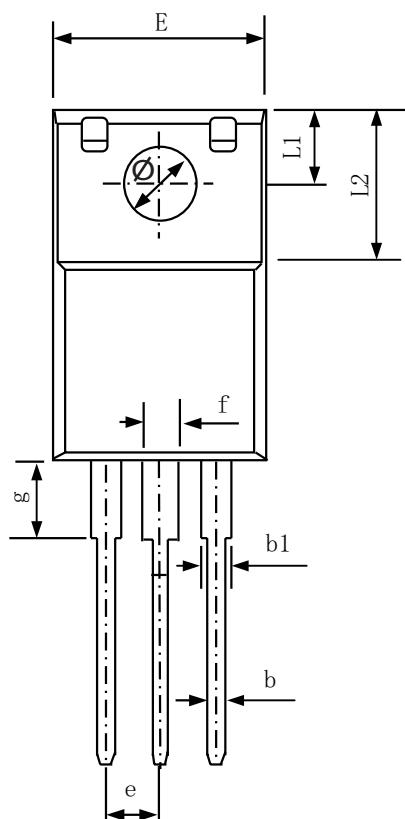
SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.32	4.80	0.170	0.189
B1	1.27	1.65	0.050	0.630
D	14.6	16.00	0.575	0.610
E	9.70	10.41	0.382	0.410
e	2.34	2.74	0.092	0.108
e1	4.68	5.48	0.184	0.216
F	1.14	1.40	0.045	0.055
H1	5.97	6.73	0.235	0.265
J1	2.20	2.79	0.087	0.110
L	12.88	14.22	0.507	0.560
L1	3.00	6.35	0.120	0.250
φP	3.50	3.94	0.138	0.155
Q	2.54	3.05	0.100	0.120

STP15L01/F

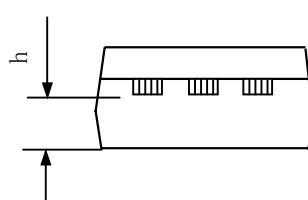
Ver 1.0

PACKAGE OUTLINE DIMENSIONS

TO-220F



SYMBOLS	MILLIMETERS	
	MIN	MAX
A	4.20	4.80
A1	1.95	2.85
b	0.56	1.05
b1	0.90	1.50
c	0.55	0.80
c2	2.50	3.10
E	9.70	10.30
L1	3.20	3.80
L2	6.90	7.50
L4	15.60	16.40
L5	13.50	14.50
Ø	3.20	
e	2.55	
f	1.30	1.90
g	3.40	3.80
h	2.10	2.70

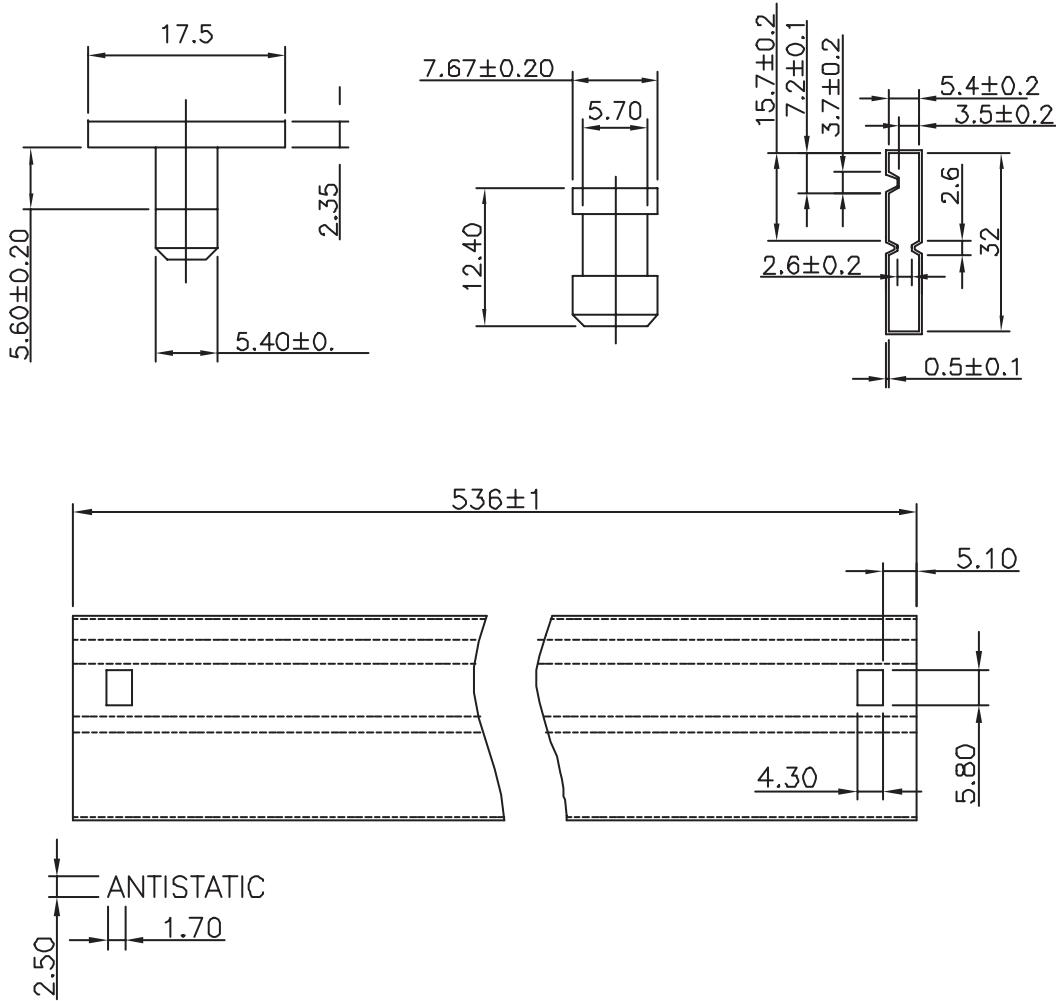


Nov,01,2010

STP15L01/F

Ver 1.0

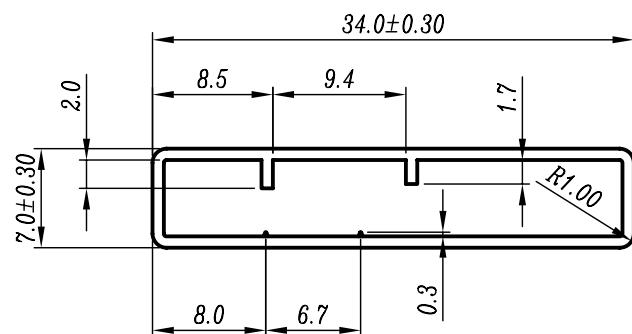
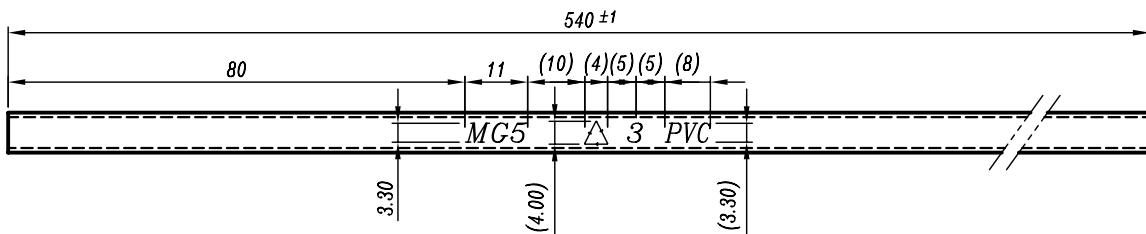
TO-220 Tube



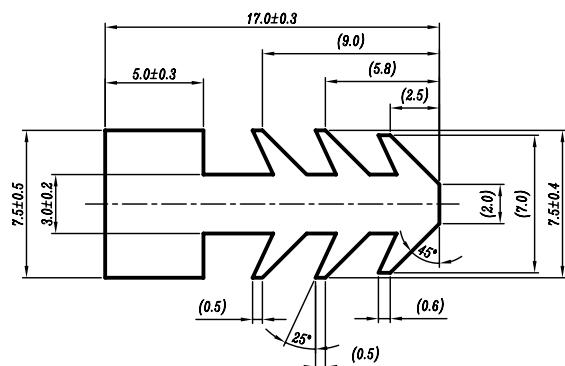
STP15L01/F

Ver 1.0

TO-220F Tube



SCALE=2/1



$L = 8.0 \pm 0.5$

Nov,01,2010